

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)} max	I _D max T _A = +25°C
04	001/	1.7Ω @ V _{GS} = 10V	500mA
Q1	60V	3Ω @ $V_{GS} = 4.5V$	400mA
00	001/	4Ω @ V _{GS} = -10V	-360mA
Q2	-60V	6Ω @ V _{GS} = -4.5V	-310mA

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- · Fast Switching Speed
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG1029SVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

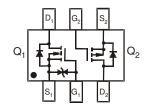
Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- General-purpose interfacing switches
- Power management functions
- Analog switches

Mechanical Data

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish—Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.027 grams (approximate)





SOT563



Top View

Bottom View

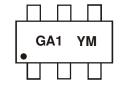
Ordering Information (Note 4)

Part Number	Compliance	Bookean	Pac	king
Part Number	Compliance	Package	Qty.	Carrier
DMG1029SVQ-7	Automotive	SOT563	3000	Tape & Reel
DMG1029SVQ-7A	Automotive	SOT563	3000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



GA1 = Product Type Marking Code YM = Date Code Marking Y or Y = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Key

Year	2009		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	W		J	K	L	М	N	0	Р	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings N-CHANNEL - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	60	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Continuous Drain Current (Note C) V 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	500 400	mA
Continuous Drain Current (Note 6) $V_{GS} = 10V$ $t<10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			I _D	620 480	mA
Maximum Body Diode Forward Current (Note 6)		Is	500	mA	
Pulsed Drain Current (Note 6)		I _{DM}	1000	mA	
Pulsed Source Current (Note 6)	•		I _{SM}	1000	mA

Maximum Ratings P-CHANNEL – Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V_{DSS}	-60	V	
Gate-Source Voltage		V _{GSS}	±20	V	
Continuous Dunin Comment (Nata C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-360 -280	mA
Continuous Drain Current (Note 6) $V_{GS} = -10V$ $t<10s$ $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			I _D	-410 -320	mA
Maximum Body Diode Forward Current (Note 6)		Is	-360	mA	
Pulsed Drain Current (Note 6)		I _{DM}	-650	mA	
Pulsed Source Current (Note 6)			I _{SM}	-650	mA

Thermal Characteristics (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 5)	$T_A = +25$ °C	D-	0.45	W	
Total Power Dissipation (Note 5)	$T_A = +70$ °C	P_{D}	0.28	VV	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Б	281	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	210	C/VV	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	D_	1	W	
Total Fower Dissipation (Note 6)	T _A = +70°C	P_{D}	0.62	VV	
Thermal Pegistanes, Junction to Ambient (Note 6)	Steady state	Б	129	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{ hetaJA}$	97	C/VV	
Operating and Storage Temperature Range	T_{J} , T_{STG}	-55 to +150	°C		

otes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL - Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	-		- 76		<u> </u>	1001 0011011
Drain-Source Breakdown Voltage		60	_	_	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}		_	10	nA	$V_{DS} = 50V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±50	nA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)			•	•	•	
Gate Threshold Voltage	V _{GS(th)}	1.0	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	0	_	1.3	1.7	Ω	$V_{GS} = 10V, I_D = 500mA$
Static Dialii-Source Oil-Nesistance	R _{DS(on)}	_	1.5	3	12	$V_{GS} = 4.5V, I_D = 200mA$
Forward Transfer Admittance		80	_	_	mS	$V_{DS} = 10V, I_D = 200mA$
Diode Forward Voltage		_	_	1.4	V	V _{GS} = 0V, I _S = 115mA
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		30	_	pF	V 05V V 0V
Output Capacitance	Coss		4.2	_	pF	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		2.9	_	pF	1 – 1.01/11/2
Total Gate Charge	Q_g	_	0.3	_	nC	V 45V V 40V
Gate-Source Charge	Q _{gs}	_	0.2	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$
Gate-Drain Charge	Q_{gd}	_	0.08	_	nC	1D = 23011A
Turn-On Delay Time	t _{D(on)}	_	3.9	_	ns	
Turn-On Rise Time	t _r	_	3.4	_	ns	$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time		_	15.7	_	ns	$R_G = 25\Omega$, $I_D = 200mA$
Turn-Off Fall Time	t _f	_	9.9		ns	

Electrical Characteristics P-CHANNEL - Q2 (@T_A = +25°C, unless otherwise specified.)

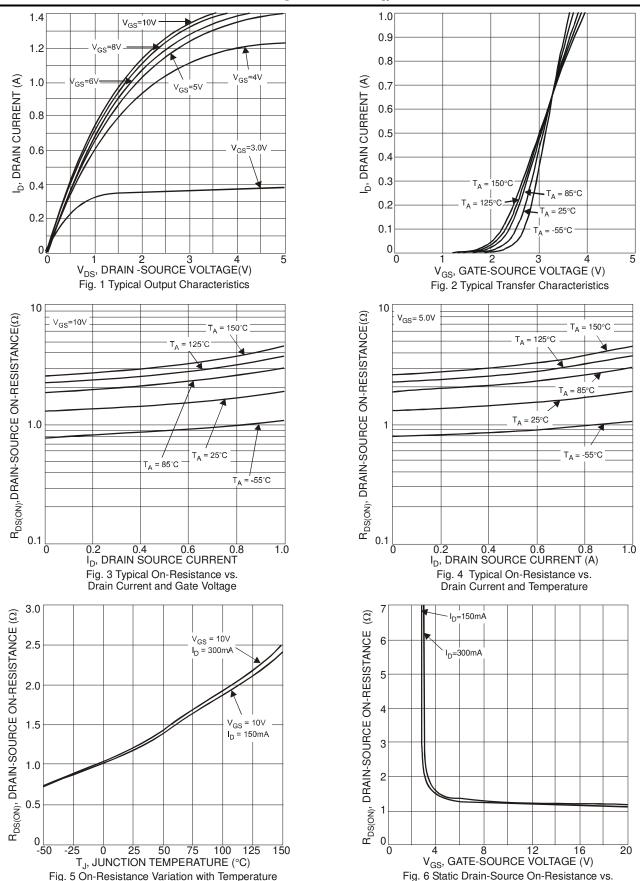
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-60	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	I _{DSS}			-25	nA	$V_{DS} = -50V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(th)}$	-1		-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
Static Drain-Source On-Resistance	D		2.7	4	Ω	$V_{GS} = -10V, I_D = -500mA$
Static Diain-Source On-Nesistance	R _{DS(on)}		3.2	6	12	$V_{GS} = -4.5V, I_D = -200mA$
Forward Transfer Admittance	$ Y_{fs} $	50	_	_	mS	$V_{DS} = -25V, I_{D} = -100mA$
Diode Forward Voltage	V_{SD}		_	-1.4	V	$V_{GS} = 0V, I_{S} = -115mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	25	_	pF	.,
Output Capacitance	Coss	1	4.7	1	pF	$V_{DS} = -25V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	1	2.7	1	pF	1 - 1.0001112
Total Gate Charge	Q_g		0.28		nC	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Gate-Source Charge	Q_{gs}		0.14	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$ $I_{D} = -500\text{mA}$
Gate-Drain Charge		_	0.08	_	nC	- ID = -300IIIA
Turn-On Delay Time	t _{D(on)}		5.5	_	ns	
Turn-On Rise Time		_	7.9		ns	V _{DD} = -30V, V _{GS} = -10V,
Turn-Off Delay Time		_	10.6	_	ns	$R_G = 50\Omega$, $I_D = -270$ mA
Turn-Off Fall Time	t _f	_	11.6	_	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.



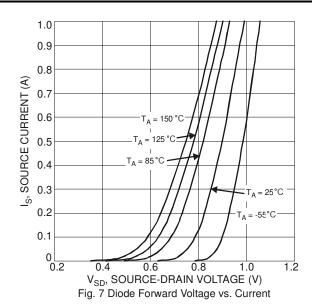
N-CHANNEL - Q1

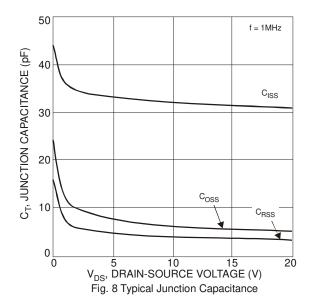


Gate-Source Voltage



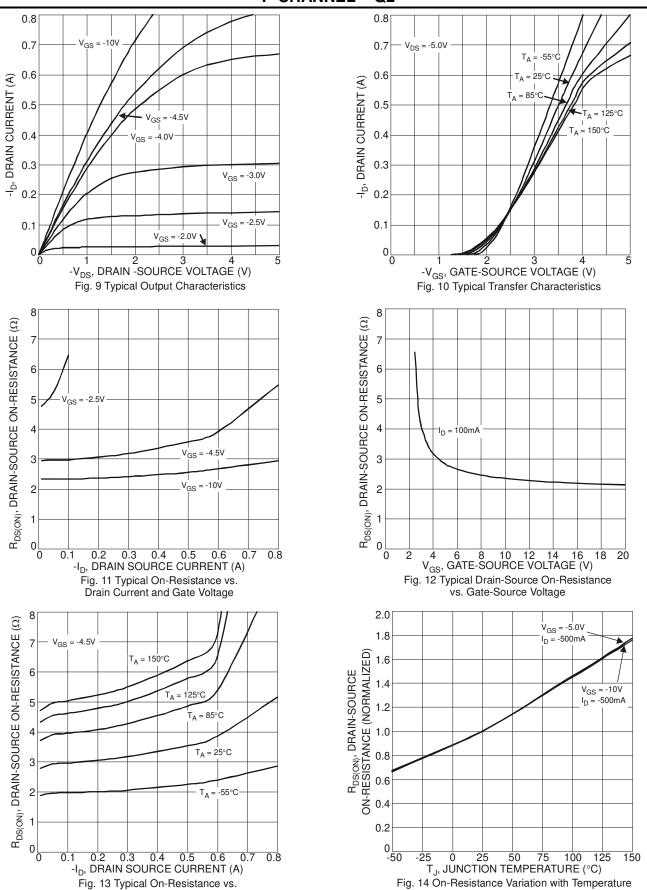
N-CHANNEL - Q1 (continued)







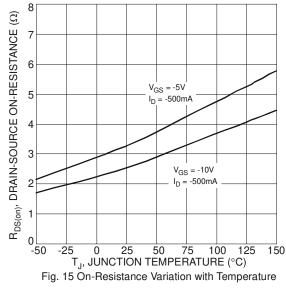
P-CHANNEL - Q2

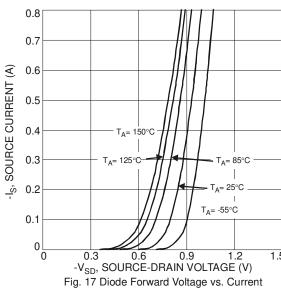


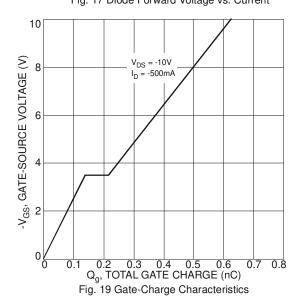
Drain Current and Temperature



P-CHANNEL - Q2 (continued)







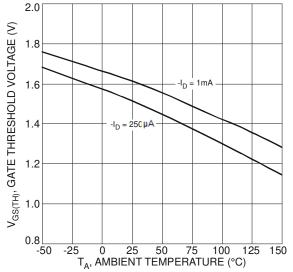
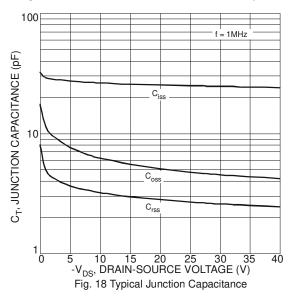


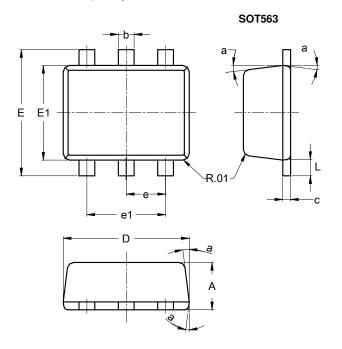
Fig. 16 Gate Threshold Variation vs. Ambient Temperature





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

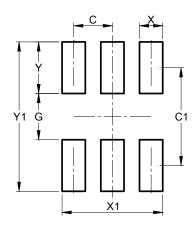


SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60					
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All	All Dimensions in mm						

Suggested Pad Layout

 $Please \ see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1 940



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